

Appl. No. 10/840,095
Amdt. dated 01/13/2007
Response to Office Action of 10/17/2006

Attorney Docket No.: N1085-00288
[TSMC2004-0032]

Amendments to the Specification:

Please replace the title with the following amended title:

**COPPER PLATING OF SEMICONDUCTOR DEVICES USING SINGLE
INTERMEDIATE LOW POWER IMMERSION STEP**